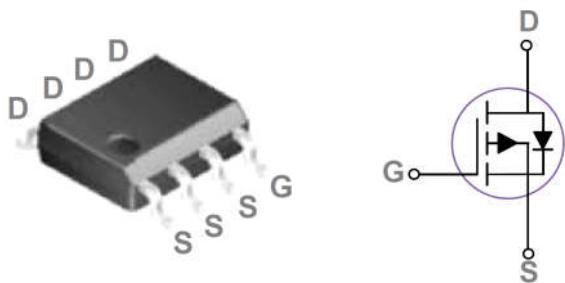


30V P-Channel MOSFETs

General Description

These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOP-8 Pin Configuration



Absolute Maximum Ratings ($T_c = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|-----------|--|------------|---------------------|
| V_{DS} | Drain-Source Voltage | -30 | V |
| V_{GS} | Gate-Source Voltage | ± 12 | V |
| I_D | Drain Current – Continuous ($T_c = 25^\circ\text{C}$) | -13 | A |
| | Drain Current – Continuous ($T_c = 100^\circ\text{C}$) | -8 | A |
| I_{DM} | Drain Current – Pulsed ¹ | -52 | A |
| P_D | Power Dissipation ($T_c = 25^\circ\text{C}$) | 2.5 | W |
| | Power Dissipation – Derate above 25°C | 0.02 | W/ $^\circ\text{C}$ |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ\text{C}$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|---------------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | | 50 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction to Case | | 5.4 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|--|------|-------|-----------|---------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}} = 0 \text{ V}$, $I_D = -250 \mu\text{A}$ | -30 | | | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D = -1 \text{ mA}$ | | -0.03 | | V/C |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}} = -30 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $T_J = 25^\circ\text{C}$ | | | -1 | μA |
| | | $V_{\text{DS}} = -24 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $T_J = 85^\circ\text{C}$ | | | -10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}} = \pm 12 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$ | | | ± 100 | nA |

On Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------------------------|---|--|------|------|------|----------------------------|
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{\text{GS}} = -4.5 \text{ V}$, $I_D = -6 \text{ A}$ | | 17 | 20 | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{GS}} = V_{\text{DS}}$, $I_D = -250 \mu\text{A}$ | -1.0 | -1.5 | -2.5 | V |
| $\Delta V_{\text{GS(th)}}$ | $V_{\text{GS(th)}}$ Temperature Coefficient | | 4 | | | $\text{mV}/^\circ\text{C}$ |
| g_{fs} | Forward Transconductance | $V_{\text{DS}} = -10 \text{ V}$, $I_D = -8 \text{ A}$ | | 10.5 | | S |

Dynamic and switching Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|---------------------|-------------------------------------|---|------|------|------|------|
| Q_g | Total Gate Charge ^{2, 3} | $V_{\text{DS}} = -15 \text{ V}$, $V_{\text{GS}} = -4.5 \text{ V}$, $I_D = -8 \text{ A}$ | | 14.6 | | nC |
| Q_{gs} | Gate-Source Charge ^{2, 3} | | | 4.1 | | |
| Q_{gd} | Gate-Drain Charge ^{2, 3} | | | 6.3 | | |
| $T_{\text{d(on)}}$ | Turn-On Delay Time ^{2, 3} | $V_{\text{DD}} = -15 \text{ V}$, $V_{\text{GS}} = -4.5 \text{ V}$, $R_G = 6 \Omega$, $I_D = -1 \text{ A}$ | | 9 | | nS |
| T_r | Rise Time ^{2, 3} | | | 21.8 | | |
| $T_{\text{d(off)}}$ | Turn-Off Delay Time ^{2, 3} | | | 59.8 | | |
| T_f | Fall Time ^{2, 3} | | | 14.4 | | |
| C_{iss} | Input Capacitance | $V_{\text{DS}} = -15 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $F = 1 \text{ MHz}$ | | 1730 | | pF |
| C_{oss} | Output Capacitance | | | 180 | | |
| C_{rss} | Reverse Transfer Capacitance | | | 125 | | |

Drain-Source Diode Characteristics and Maximum Ratings

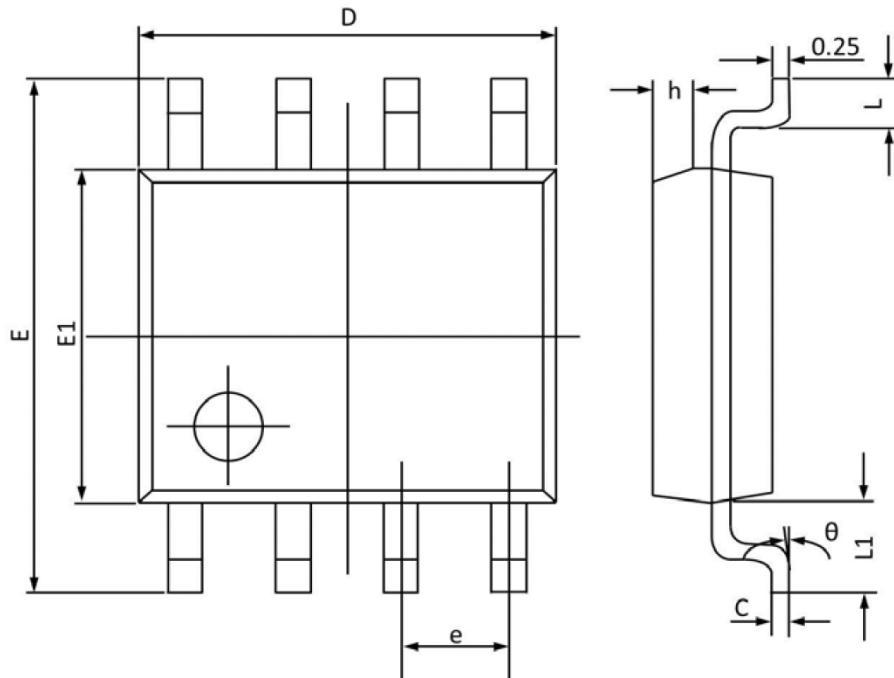
| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|--|------|------|------|------|
| I_S | Continuous Source Current | $V_G = V_D = 0 \text{ V}$, Force Current | | | -13 | A |
| I_{SM} | Pulsed Source Current | | | | -26 | A |
| V_{SD} | Diode Forward Voltage | $V_{\text{GS}} = 0 \text{ V}$, $I_S = 1 \text{ A}$, $T_J = 25^\circ\text{C}$ | | | -1 | V |

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

Package Information

SOP-8



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | MAX | MIN | MAX | MIN |
| A | 1.150 | 0.900 | 0.045 | 0.035 |
| A1 | 0.100 | 0.000 | 0.004 | 0.000 |
| A2 | 1.050 | 0.900 | 0.041 | 0.035 |
| b | 0.500 | 0.300 | 0.020 | 0.012 |
| c | 0.150 | 0.080 | 0.006 | 0.003 |
| D | 3.000 | 2.800 | 0.118 | 0.110 |
| E | 1.400 | 1.200 | 0.055 | 0.047 |
| E1 | 2.550 | 2.250 | 0.100 | 0.089 |
| e | 0.95 TYP. | | 0.037 TYP. | |
| e1 | 2.000 | 1.800 | 0.079 | 0.071 |
| L | 0.55 REF. | | 0.022 REF. | |
| L1 | 0.500 | 0.300 | 0.020 | 0.012 |
| L2 | 0.25 TYP. | | 0.01 TYP. | |
| θ | 8° | 0° | 8° | 0° |

V 1.0